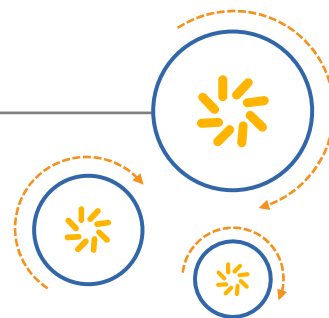




RF360 Europe GmbH
A Qualcomm – TDK Joint Venture

SAW components

SAW RF filter

GPS/Glonass/Galileo/Beidou

Series/type:	B3412
Ordering code:	B39162B3412U410
Date:	October 20, 2017
Version:	2.4

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SAW components**B3412****SAW RF filter****1587.5 MHz**

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SAW components

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SAW RF filter

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1 Application

- Low-loss RF filter for GPS/Glonass/Galileo/Beidou application
- Unbalanced to unbalanced operation
- Usable pass band 57.0 MHz
- No matching required for operation at 50 Ω

2 Features

- Package size 3.0±0.1 mm × 3.0±0.1 mm
- Package height 1.1±0.125 mm
- Package code DCC6C
- Approximate weight 0.04 g
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Lead free soldering compatible with J-STD20C
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 1 (MSL1)
- AEC-Q200 qualified component family (Grade 1: -40 °C to +125 °C)

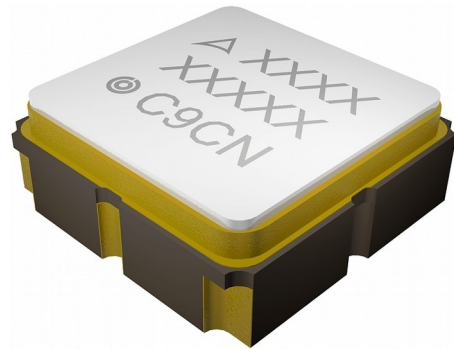


Figure 1: Picture of component with example of product marking.

SAW components

B3412

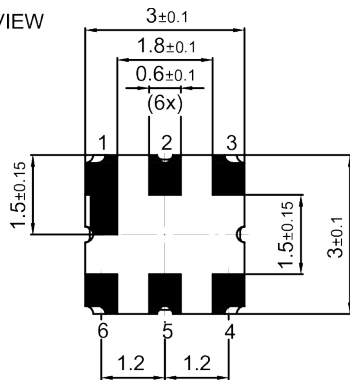
SAW RF filter

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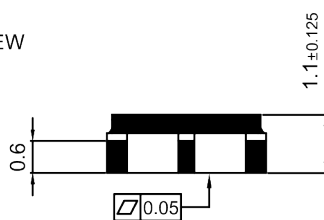
Data sheet

3 Package

BOTTOM VIEW

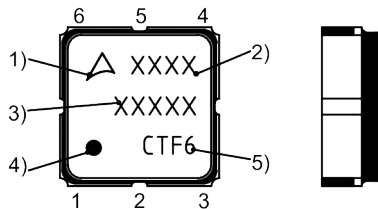


SIDE VIEW



TOP VIEW

SIDE VIEW



- 1) Company logo
- 2) Device designation
- 3) Last five digits of the lot number
- 4) Marking for pad number 1
- 5) Example of production location and date code

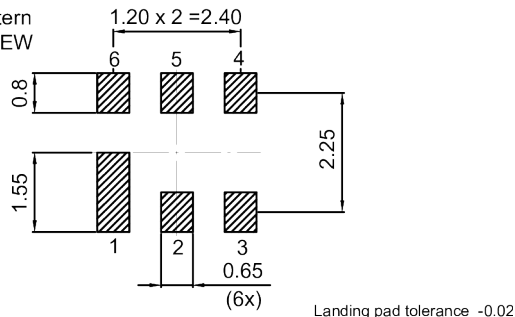
Land pattern
THRU VIEW

Figure 2: Drawing of package. See Sec. Package information (p. 18).

4 Pin configuration

- 2 Input
- 5 Output
- 1, 3, 4, 6 Ground

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5 Matching circuit

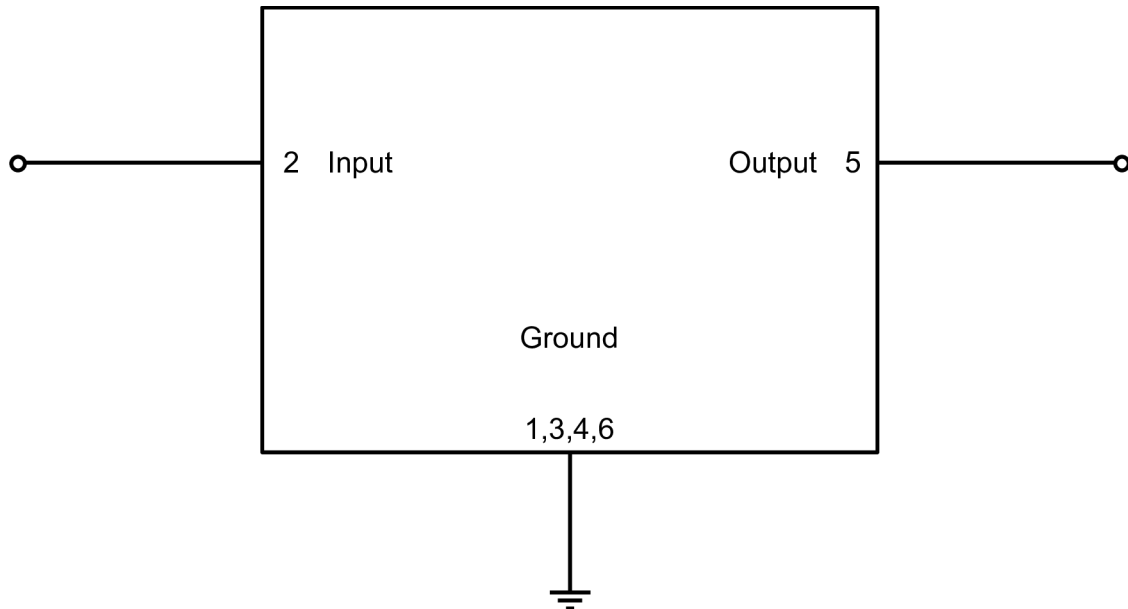


Figure 3: Schematic of matching circuit. No external matching components required.

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6 Characteristics

Temperature range for specification

$$T_{\text{SPEC}} = -40\text{ °C} \dots +85\text{ °C}$$

Input terminating impedance

$$Z_{\text{IN}} = 50\ \Omega$$

Output terminating impedance

$$Z_{\text{OUT}} = 50\ \Omega$$

Characteristics			min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}	
Center frequency		f_{C}	—	1587.5	—	MHz
Maximum insertion attenuation		α_{max}	—	1.8	2.6	dB
	1559... 1616	MHz	—	1.8	2.6	dB
Amplitude ripple (p-p)		$\Delta\alpha$	—	0.7	1.7	dB
	1559... 1616	MHz	—	0.7	1.7	dB
Maximum group delay		τ_{max}	—	12	30	ns
	1559... 1616	MHz	—	12	30	ns
Maximum VSWR		VSWR_{max}	—	1.7	2.2	
@ input port	1559... 1616	MHz	—	1.7	2.2	
@ output port	1559... 1616	MHz	—	1.7	2.2	
Minimum attenuation		α_{min}				
	10... 950	MHz	35	42	—	dB
	950... 1180	MHz	40	46	—	dB
	1180... 1300	MHz	34	42	—	dB
	1300... 1440	MHz	30	39	—	dB
	1440... 1490	MHz	23	28	—	dB
	1490... 1525	MHz	15	21	—	dB
	1645... 1710	MHz	15	21	—	dB
	1710... 2000	MHz	25	31	—	dB
	2000... 2500	MHz	20	25	—	dB

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7 Maximum ratings

Operable temperature	$T_{OP} = -45\text{ °C} \dots +125\text{ °C}$	
Storage temperature	$T_{STG}^{1)} = -45\text{ °C} \dots +125\text{ °C}$	
DC voltage	$ V_{DC} = 6.0\text{ V}$	
ESD voltage		
	$V_{ESD}^{2)} = 150\text{ V (max.)}$	Human body model.
	$V_{ESD}^{3)} = 125\text{ V (max.)}$	Machine model.
Source power	$P_S = 10\text{ dBm}$	Source impedance 50 Ω.

1) Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

2) According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.

3) According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.

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8 Transmission coefficient

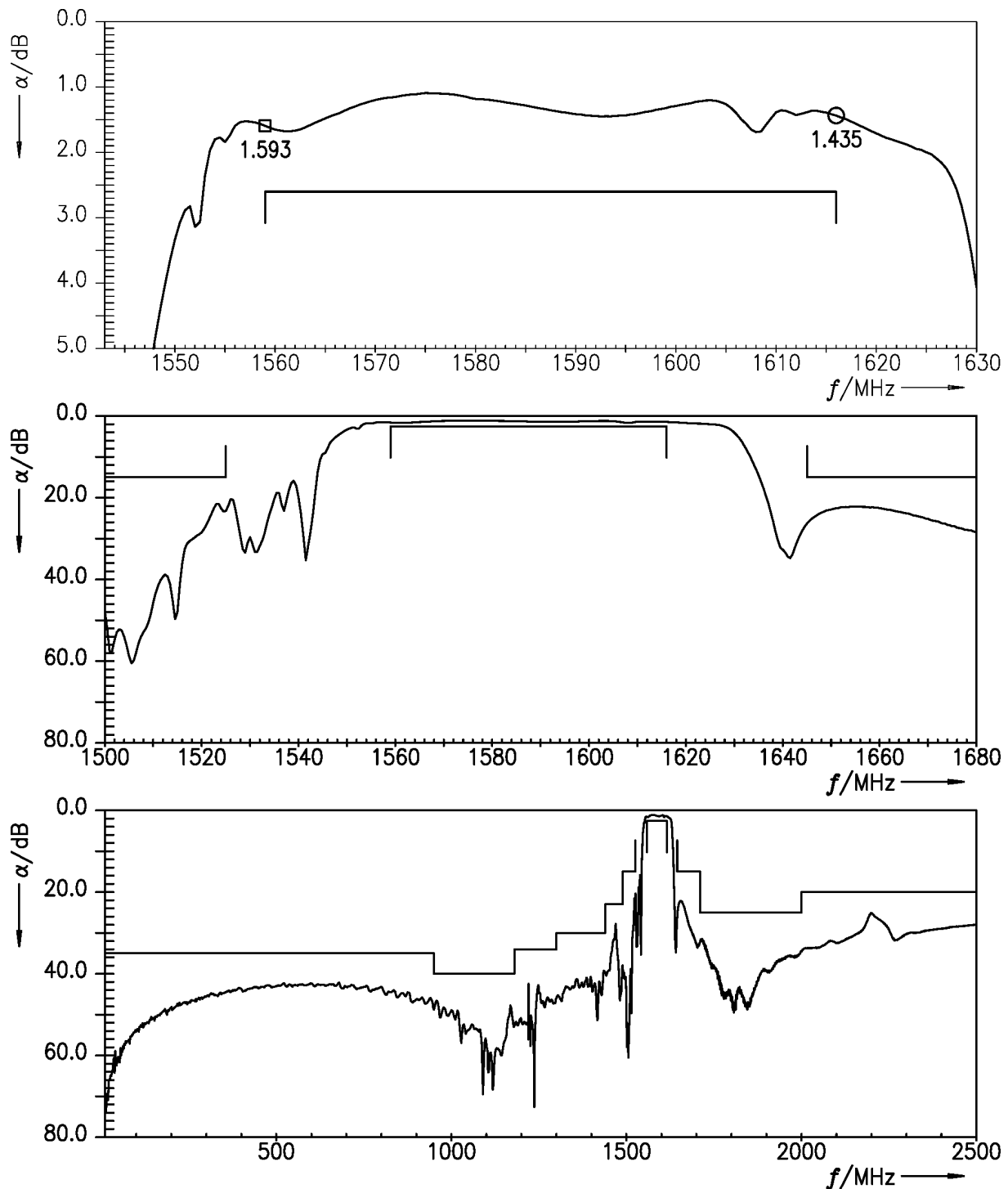


Figure 4: Attenuation.

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9 Reflection coefficients

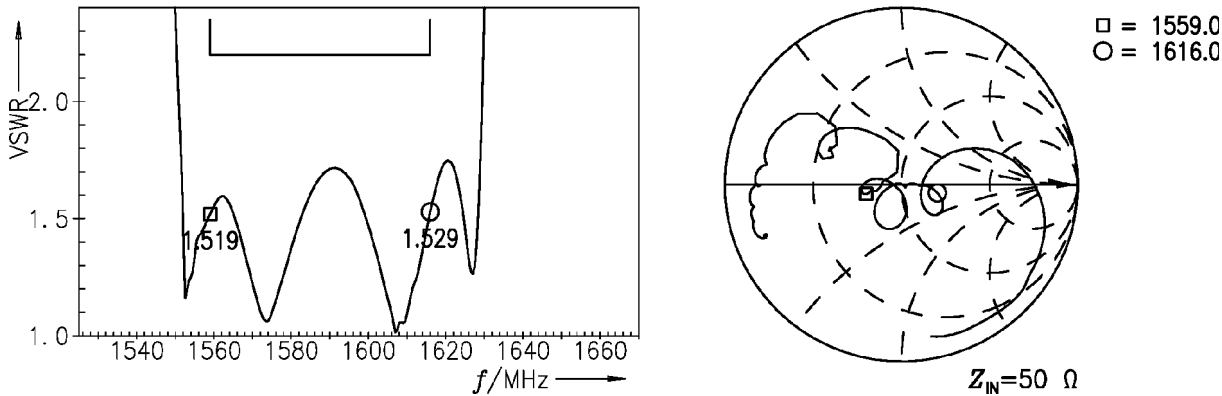


Figure 5: Reflection coefficient at IN port.

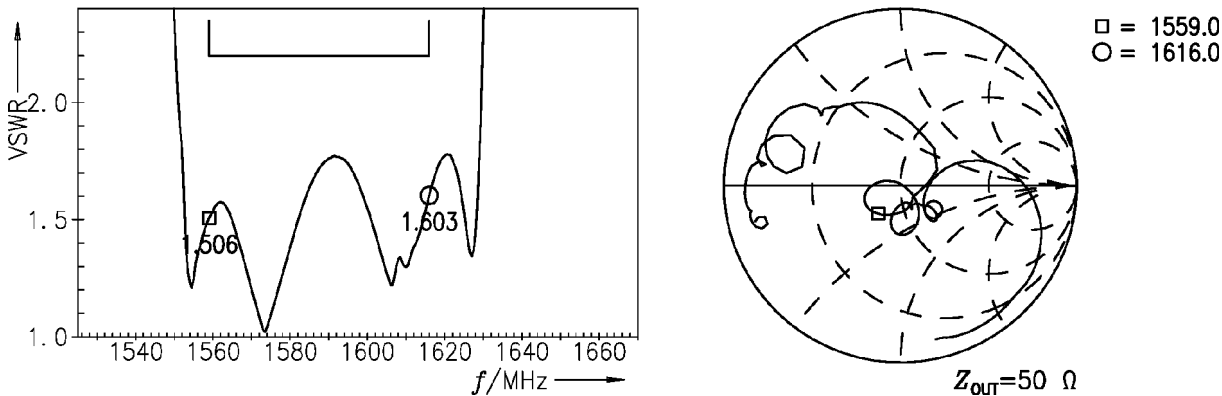


Figure 6: Reflection coefficient at OUT port.

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10 Group delay

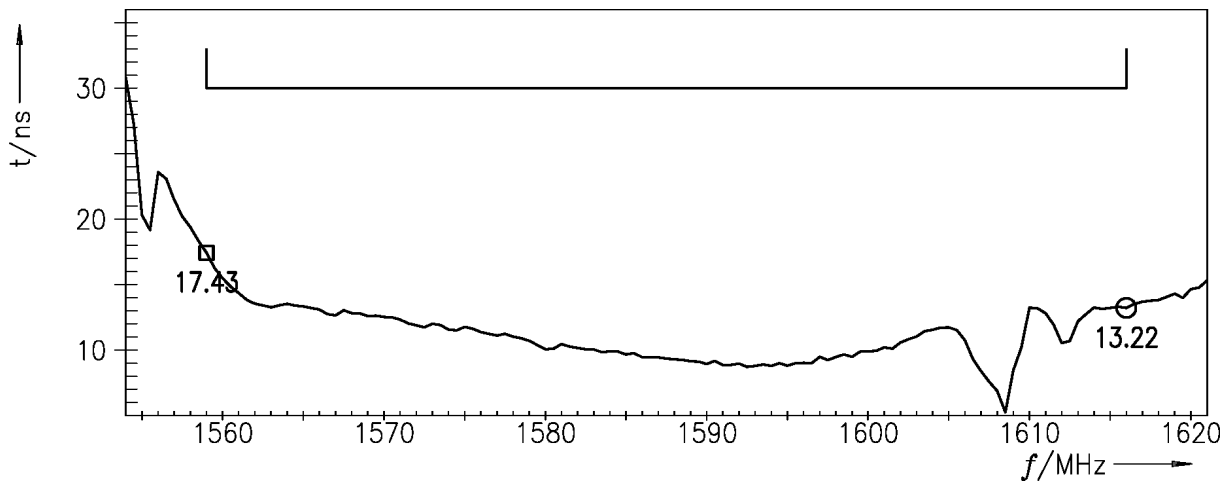


Figure 7: Group delay.

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11 Packing material

11.1 Tape

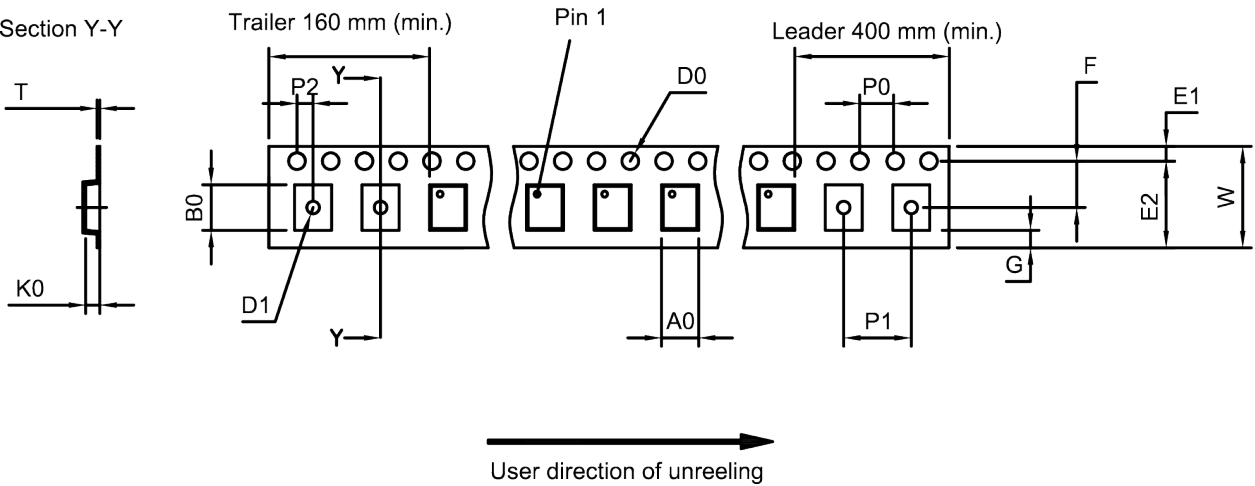


Figure 8: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A ₀	3.25±0.1 mm	E ₂	10.25 mm (min.)	P ₁	4.0±0.1 mm
B ₀	3.3±0.1 mm	F	5.5±0.05 mm	P ₂	2.0±0.1 mm
D ₀	1.5+0.1/-0 mm	G	0.75 mm (min.)	T	0.2±0.05 mm
D ₁	1.5 mm (min.)	K ₀	1.5±0.1 mm	W	12.0+0.3/-0.1 mm
E ₁	1.75±0.1 mm	P ₀	4.0±0.1 mm		

Table 1: Tape dimensions.

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11.2 Reel with diameter of 330 mm

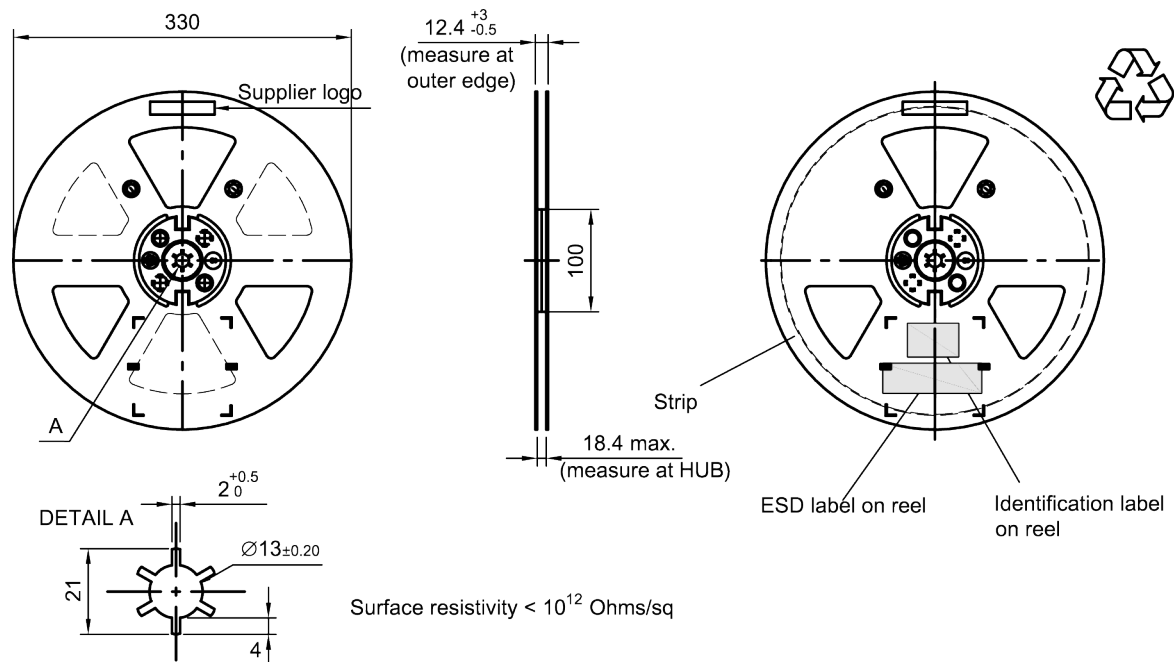
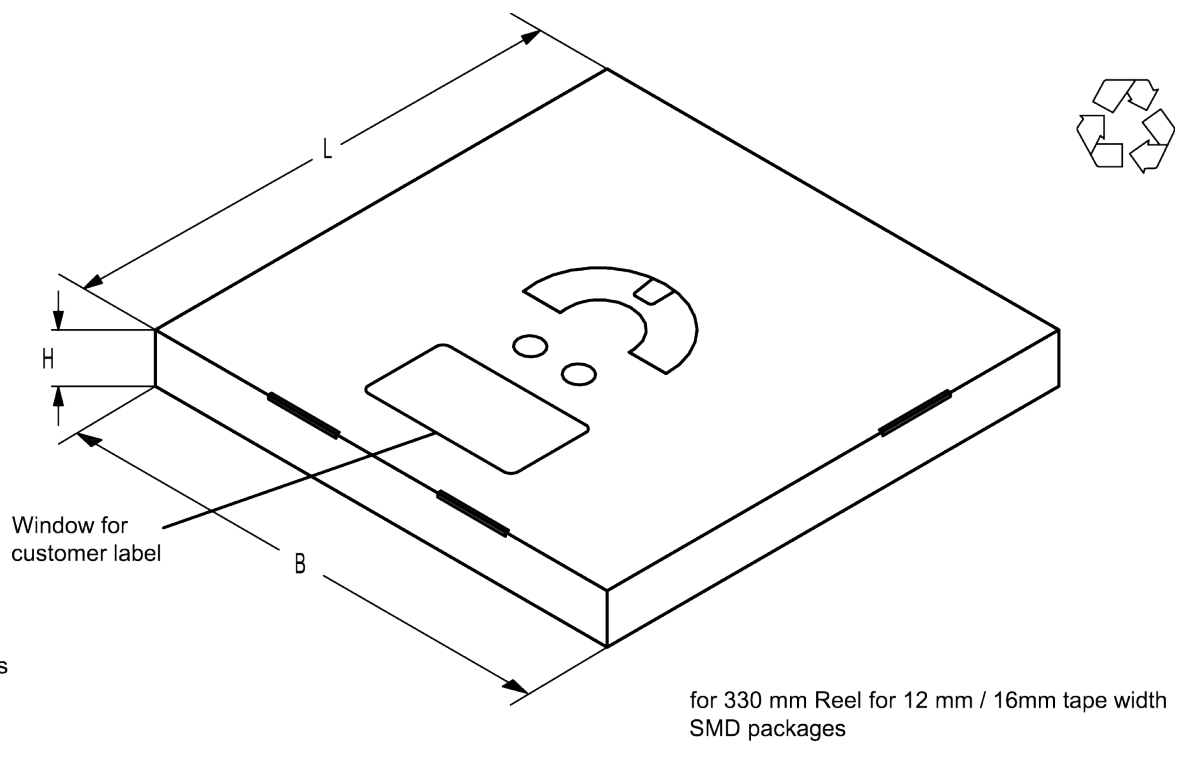


Figure 9: Drawing of reel (first-angle projection) with diameter of 330 mm.



Dimensions

L = 340

B = 340

H = 25

Figure 10: Drawing of folding box for reel with diameter of 330 mm.

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12 Marking

Products are marked with device designation, lot number, as well as production location and date code.

- Device designation: The 4-character device designation of the ordering code is used for the marking.

Example for 4-character device designation: B3xxxxB1234xxxx

- Lot number: The last 5 digits of the lot number are used for the marking.

Example: 12345

- Production location and date code: The production location is Wuxi (encoded in the first character 'C'). The production date code is encoded in the last three characters according to Table 2.

1 st digit (day)						2 nd digit (year)				3 rd digit (month)			
Day	Code	Day	Code	Day	Code	Year	Code	Year	Code	Month	Code	Month	Code
1	1	11	A	21	M	2010	A	2022	P	Jan	1	Jul	7
2	2	12	B	22	N	2011	B	2023	R	Feb	2	Aug	8
3	3	13	C	23	P	2012	C	2024	S	Mar	3	Sep	9
4	4	14	D	24	R	2013	D	2025	T	Apr	4	Oct	0
5	5	15	E	25	S	2014	E	2026	U	May	5	Nov	N
6	6	16	F	26	T	2015	F	2027	V	Jun	6	Dec	D
7	7	17	H	27	U	2016	H	2028	W				
8	8	18	J	28	V	2017	J	2029	X				
9	9	19	K	29	W	2018	K	2030	Z				
10	0	20	L	30	X	2019	L	2031	A				
				31	Z	2020	M	2032	B				
						2021	N	and so on					

Table 2: Production date code.

Example of how to decode production location and date code:

Code: **C T F 6**

Location: C → Wuxi

Day: T → 26th

Year: F → 2015

Month: 6 → June

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13 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
T ≥ 255 °C	–
peak temperature T _{peak}	250 °C +0/-5 °C
wetting temperature T _{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

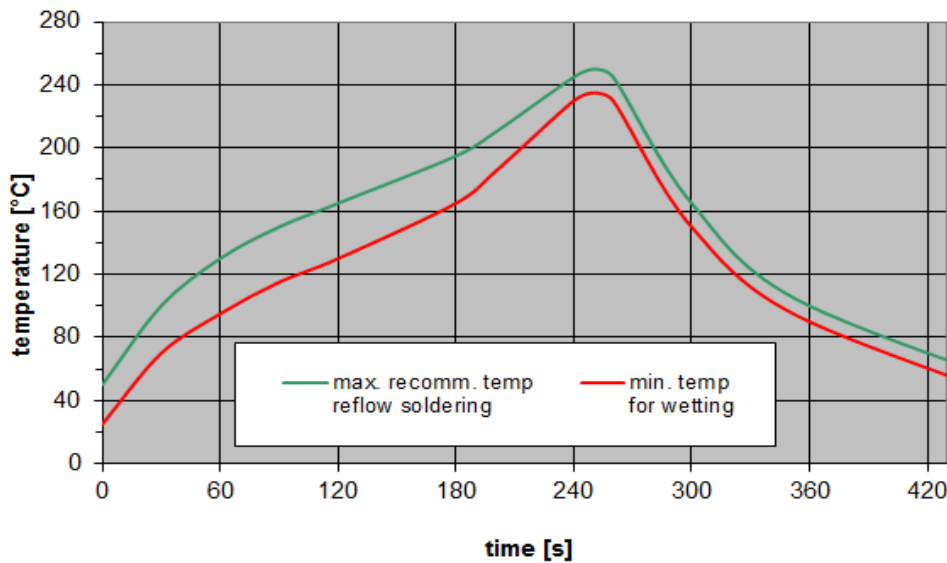


Figure 11: Recommended reflow profile for convection and infrared soldering – lead-free solder.

Data sheet

14 ESD protection of SAW filters

SAW filters are **E**lectro **S**tatic **D**ischarge sensitive devices. To reduce the probability of damages caused by ESD, special matching topologies have to be applied.

In general, “ESD matching” has to be ensured at that filter port, where electrostatic discharge is expected.

Electrostatic discharges predominantly appear at the antenna input of RF receivers. Therefore, only the input matching of the SAW filter has to be designed to short circuit or to block the ESD pulse.

Below three figures show recommended “ESD matching” topologies.

For wide band filters the high-pass ESD matching structure needs to be at least of 3rd order to ensure a proper matching for any impedance value of antenna and SAW filter input. The required component values have to be determined from case to case.

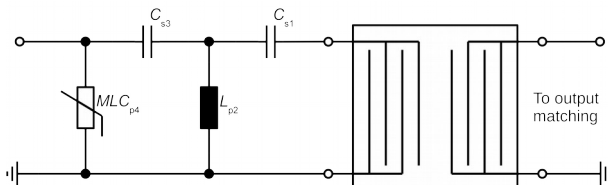


Figure 12: MLC varistor plus ESD matching.

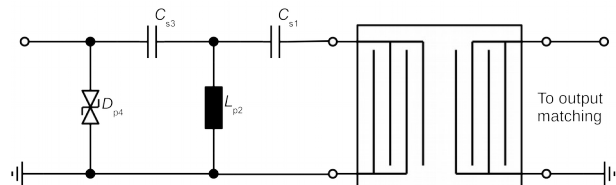


Figure 13: Suppressor diode plus ESD matching.

In cases where minor ESD occur, following simplified “ESD matching” topologies can be used alternatively.

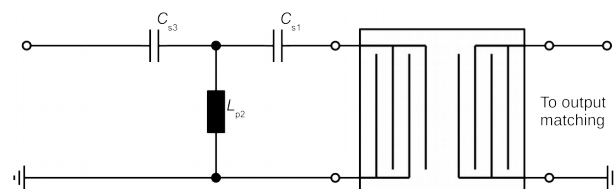


Figure 14: 3rd order high-pass structure for basic ESD protection.

In all three figures the shunt inductor L_{p2} could be replaced by a shorted microstrip with proper length and width. If this configuration is possible depends on the operating frequency and available PCB space.

Effectiveness of the applied ESD protection has to be checked according to relevant industry standards or customer specific requirements.

For further information, please refer to RF360 Application report: “**ESD protection for SAW filters**”. This report can be found under www.rf360jv.com/rke. Click on “Applications Notes”.

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15 Annotations

15.1 Matching coils

See TDK inductor pdf-catalog <http://www.tdk.co.jp/tefe02/coil.htm#aname1> and Data Library for circuit simulation <http://www.tdk.co.jp/etvcl/index.htm>.

15.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

15.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

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16 Cautions and warnings**16.1 Display of ordering codes for RF360 products**

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

16.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

16.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

16.4 Package information**Landing area**

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.

Important notes

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3. **The warnings, cautions and product-specific notes must be observed.**
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